



Publishing Open access articles with the IEEE - Webinar for University of West-Bohemia

Presented by:

Eszter Lukács

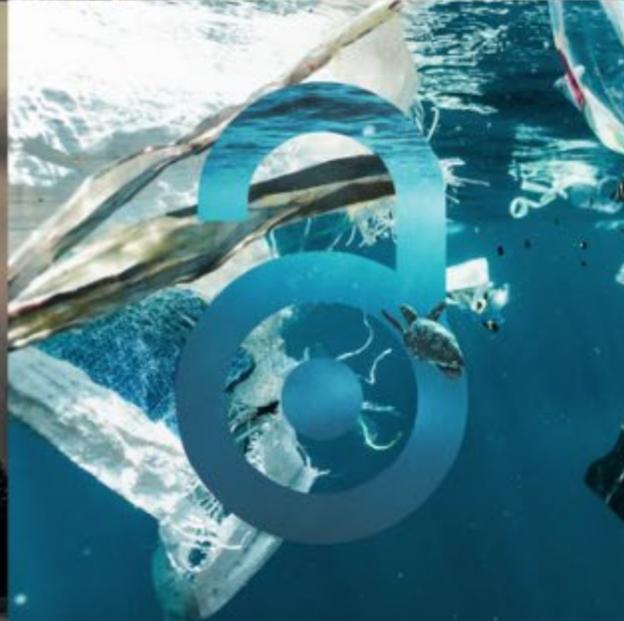
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**International
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A team of 150 IEEE volunteers from Nigeria developed a robot that uses vital signals to detect, prevent and mitigate the spread of Covid-19 in hospitals.

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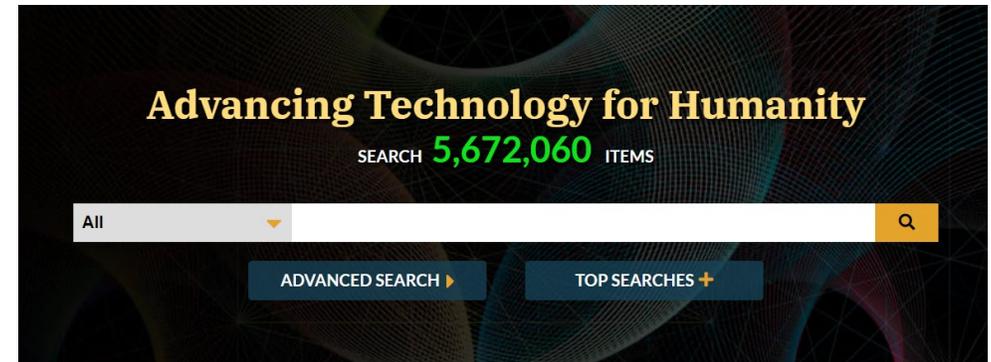
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2022:

- IEEE Open Journal of Control Systems
- IEEE Journal on Flexible Electronics
- IEEE Open Journal of Instrumentation and Measurement
- IEEE Transactions on Signal and Power Integrity
- TUP International Crowd Science
- iEnergy

Coming in 2023:

- IEEE Trans on AgriFood Electronics
- IEEE Electron Devices Magazine
- IEEE Transactions on Energy Markets, Policy and Regulation
- IEEE Transactions on Industrial Cyber-Physical Systems
- IEEE Microwave and Wireless Technology Letters
- IEEE Transactions on Radar Systems

*Please note this is a tentative list and is subject to change.

IEEE Open Journal of
Control Systems

2022 Volume 1 IOJCD4 (ISSN 2694-085X)

An Open Access Journal of
the Control Systems Society

IEEE
Control Systems
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IEEE JOURNAL ON
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A PUBLICATION OF
THE IEEE SENSORS COUNCIL
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JANUARY 2022 VOLUME 1 NUMBER 1 IJFEBL (ISSN 2768-167X)



IEEE Open Journal of
**Instrumentation
and
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2022 Volume 1

An Open Access
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INTERNATIONAL JOURNAL OF
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Volume 6, Number 1, 2022

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IEEE Conferences Continue to Address Research in New and Emerging Technologies

Some examples of conferences published in 2021 covering innovative technologies that can transform our world:

- 2021 IEEE Int'l **Solid-State Circuits** Conference (ISSCC)
- 2021 4th Int'l Conf on **Artificial Intelligence** and Big Data
- 2021 32nd Annual SEMI Advanced **Semiconductor Manufacturing** Conf
- 2021 7th Int'l Conf on Automation, **Robotics** and Applications (ICARA)
- 2021 IEEE 93rd **Vehicular Technology** Conf (VTC2021-Spring)
- 2021 IEEE 2nd Int'l Conf on Big Data, AI, and **Internet of Things** Engineering
- 2021 8th IEEE Int'l Conf on **Cyber Security** and Cloud Computing (CSCloud)
- 2021 16th Int'l Conf on Ecological Vehicles and **Renewable Energies** (EVER)
- 2021 IEEE PES Innovative **Smart Grid** Technologies Conference (ISGT)
- 2021 5th Int'l Conf on **Internet of Things** and Applications (IoT)
- 2021 Joint European Conf on Networks and Communications & **6G** Summit

Note: this is a partial listing of new conferences and is not all-inclusive or final. Information is subject to change.



IEEE PES T&D Conf 2022 in New Orleans



IEEE Asia Pacific Conf, TENSYP in Bangladesh

Over 200k new papers posted in 2021!

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Transportation
And more...

The screenshot shows the IEEE Xplore Digital Library homepage. The navigation bar at the top includes the IEEE Xplore logo, a 'Browse' dropdown menu, 'My Settings', a 'Help' dropdown menu, and a partially visible 'Institution' dropdown menu. The 'Help' dropdown menu is open, showing 'Contact Us' and 'Resources and Help' options, with red arrows pointing to them. The main banner features the slogan 'Advancing Technology for Humanity' in yellow text, a search bar with the text 'SEARCH 5,335,719 ITEMS', and a search button. Below the search bar are two buttons: 'ADVANCED SEARCH' and 'TOP SEARCHES'. Red arrows point to both of these buttons. The background of the page is a dark blue and black digital-themed graphic with glowing lines and a large circular arrow icon.

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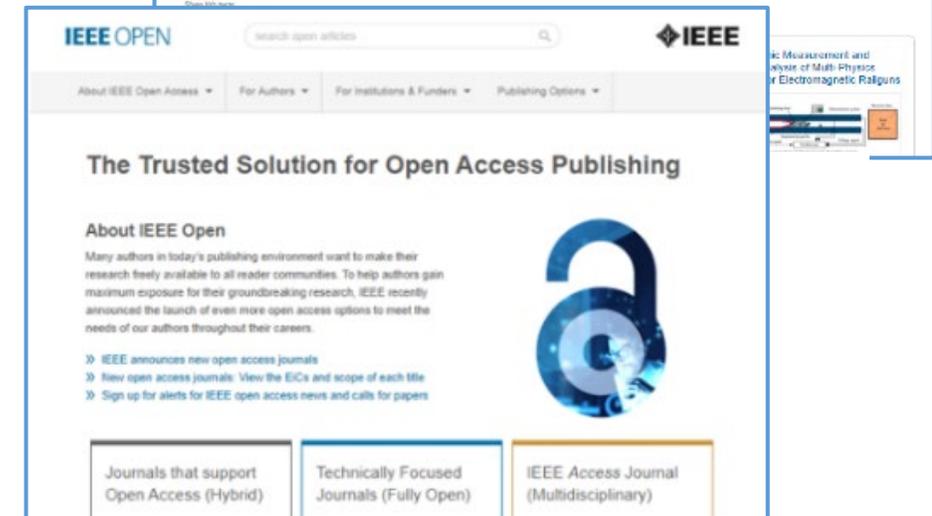
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OA Publishing Options

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3. **Multidisciplinary OA journal - IEEE Access**
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With the above options for authors, IEEE has published over 80,000 open access articles in IEEE *Xplore*.



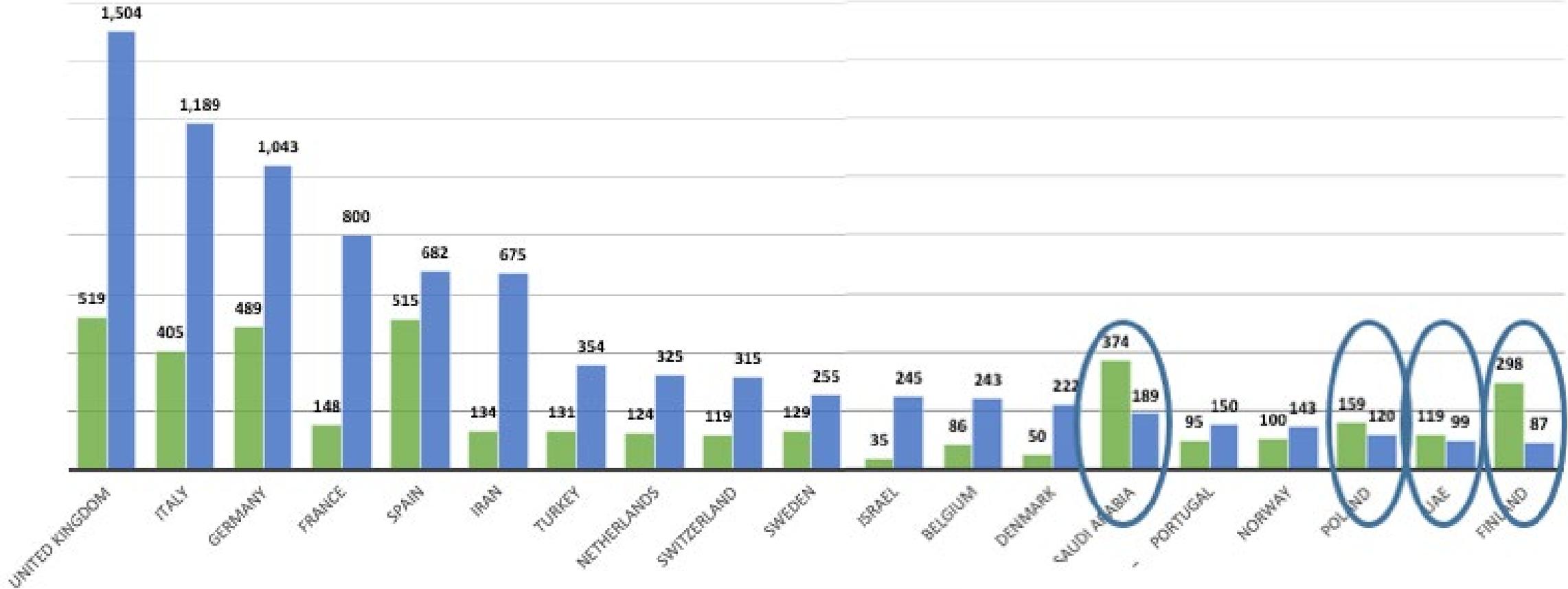
In all, IEEE publishes 26 fully Open Access journals

In the last 18 months, we have launched 17 new journals and flipped 2 existing journals to Open Access

- ▶ IEEE Access
- ▶ IEEE Journal of Electron Devices Society
- ▶ IEEE Journal of Exploratory Solid-State Computational Devices and Circuits
- ▶ *IEEE Journal of Microwaves – NEW!*
- ▶ *IEEE Journal of Selected Topics in Applied Earth Observations and Remote Sensing – FLIPPED!*
- ▶ IEEE Journal of Translational Engineering in Health and Medicine
- ▶ *IEEE Open Access Journal of Power and Energy – RETITLED!*
- ▶ *IEEE Open Journal of Antennas and Propagation – NEW!*
- ▶ *IEEE Open Journal of Circuits and Systems – NEW!*
- ▶ *IEEE Open Journal of Engineering in Medicine and Biology – NEW!*
- ▶ *IEEE Open Journal of Industry Applications – NEW!*
- ▶ *IEEE Open Journal of Intelligent Transportation Systems – NEW!*
- ▶ *IEEE Open Journal of Nanotechnology – NEW!*
- ▶ *IEEE Open Journal of Power Electronics – NEW!*
- ▶ *IEEE Open Journal of Signal Processing – NEW!*
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- ▶ *IEEE Open Journal of the Computer Society – NEW!*
- ▶ *IEEE Open Journal of the Industrial Electronics Society – NEW!*
- ▶ *IEEE Open Journal of the Solid-State Circuits Society – NEW!*
- ▶ *IEEE Open Journal of Ultrasonics, Ferroelectrics, and Frequency Control – NEW!*
- ▶ *IEEE Open Journal of Vehicular Technology – NEW!*
- ▶ IEEE Photonics Journal (flipped in 2012)
- ▶ *IEEE Transactions on Neural Systems and Rehabilitation Engineering – FLIPPED!*
- ▶ *IEEE Transactions on Quantum Engineering – NEW!*
- ▶ *IEEE Open Journal of Control Systems – COMING in 2022!*
- ▶ *IEEE Open Journal of Instrumentation and Measurement – COMING in 2022!*

Europe & Middle East: Journal Article Output 2021

Corresponding author data – open access vs traditional publishing



Source: IEEE Publications Department, 2021 Publishing Data based on order date
March 2022

- Vaclav Kotlan (3)
- Miroslav Simandl (2)
- Anouar Belahcen (2)
- Sanat K. Biswas (2)
- Saeed Roshani (2)
- Thomas Pany (2)
- Andrew G. Dempster (2)
- Sobhan Roshani (2)
- Bohumil Skala (2)



Sort By: **Relevance** ▼

Int-Mass Filter and Predictor 
ndner

isher: IEEE

Losses under Current Harmonics Operation 
ik; Zdeněk Frank; Jan Laksar; Zdeněk Peroutka

Efficient Motor Drive for Mine Hoist 
; Karel Zeman

isher: IEEE

Showing 1-17 of 17 for ("Author Affiliations": "univ* of west bohemia") x

▼ Filters Applied: Journals x Magazines x Early Access Articles x



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- All Results
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- Open Access Only



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Sort By: Relevance ▼

Artificial Intelligence and COVID-19: Deep Learning Approaches for Diagnosis and Treatment

Mohammad Jamshidi; Ali Lalbakhsh; Jakub Talla; Zdeněk Peroutka; Farimah Hadjilooei; Pedram Lalbakhsh; Morteza Jamshidi; Luigi La Spada; Mirhamed Mirmozafari; Mojgan Dehghani; Asal Sabet; Saeed Roshani; Sobhan Roshani; Nima Bayat-Makou; Bahare Mohamadzade; Zahra Malek; Alireza Jamshidi; Sarah Kiani; Hamed Hashemi-Dezaki; Wahab Mohyuddin
IEEE Access

Year: 2020 | Volume: 8 | Journal Article | Publisher: IEEE

Cited by: Papers (168)

► Abstract HTML  



Year



Single Year

Range

2015

2022

From

To

2015

2022

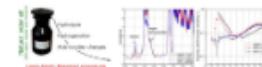
Various Aging Processes in a Paper-Natural Ester Insulation System in the Presence of Copper and Moisture

Pavel Trnka; Jaroslav Hornak; Pavel Prosr; Ondrej Michal; Feipeng Wang
IEEE Access

Year: 2020 | Volume: 8 | Journal Article | Publisher: IEEE

Cited by: Papers (12)

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Author



Affiliation



Publication Title



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The screenshot shows the IEEE Transactions on Fuzzy Systems journal page. At the top, there is a breadcrumb trail: "Browse Journals & Magazines > IEEE Transactions on Fuzzy Sys...". The journal title "IEEE Transactions on Fuzzy Systems" is prominently displayed in green. To the right of the title are three icons: "Submit Manuscript", "Add Title To My Alerts", and a RSS feed icon. Below the title is a navigation bar with tabs for "Home", "Popular", "Early Access", "Current Issue", "All Issues", and "About Journal". The "About Journal" tab is currently selected. Below the navigation bar, three key metrics are displayed in green boxes: "8.759 Impact Factor", "0.01844 Eigenfactor", and "2.05 Article Influence Score". A question mark icon is next to the Article Influence Score. Below these metrics is a section titled "Aims & Scope" with an upward-pointing arrow. To the left of the "Aims & Scope" section is a sidebar titled "Author Resources" containing links for "Submission Guidelines", "Submit Manuscript", and "Author Center". The main content area under "Aims & Scope" contains the following text: "The IEEE Transactions on Fuzzy Systems publishes high quality technical papers in the theory, design, and application of fuzzy systems. Readers are encouraged to submit papers which disclose significant technical knowledge, exploratory developments and applications of fuzzy systems. Emphasis is given to engineering systems and scientific applications. The Transactions also contains a letters section which includes information of current interest, and comments and rebuttals submitted in connection with published papers."

▼ **Conferences:** (714 results) Sort By:

SHOW MAP

Title Location	Country	Abstract Submission Deadline	Conference Date
2021 Machine Learning-Driven Digital Technologies for Educational Innovation Workshop Location: Monterrey, Mexico	Mexico		15-17 Dec 2021
2021 IEEE 2nd International Conference on Pattern Recognition and Machine Learning (PRML) Location: Sichuan University, Wangjiang Campus, No.24 South Section 1, Yihuan Road, Chengdu, China	China		16-18 Jul 2021
2021 ACM/IEEE 3rd Workshop on Machine Learning for CAD (MLCAD)	USA	28 May 2021	31 Aug-02 Sep 2021

result current as of: 2021-Apr-15 14:24:50Z

▼ **Periodicals:** (199 results) Sort By:

Title	Open Access Availability	Impact Factor	Submission to Publication Time in Xplore
Learning Technologies, IEEE Transactions on	Open Access Available	2.714	45.8 Weeks
Neural Networks and Learning Systems, IEEE Transactions on	Open Access Available	8.793	49.5 Weeks
Human-Machine Systems, IEEE Transactions on	Open Access Available	3.374	49.9 Weeks
Pattern Analysis and Machine Intelligence, IEEE Transactions on	Open Access Available	17.861	41.9 Weeks

Publishing Outlets: Conference or Journal?

- ▶ **Conferences** are for preliminary findings of ongoing research
- ▶ **Journals** are for fully-developed findings of completed research
- ▶ **Both** are peer-reviewed and checked for plagiarism before publication
- ▶ **Open Access** is only available for journals at this time

Note:

Authors are expected to present their findings in person at a conference in order to be published in the conference proceedings

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conference website
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Submission

Choosing Where to Submit – in IEEE *Xplore*

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Search by keywords



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Displaying Results 1-25 of 223

Filters Applied: IEEE 



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Show

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Show active titles only



IEEE Access

Publisher: IEEE Years: 2013 - Present Most Recent Issue

IEEE Aerospace and Electronic Systems Magazine

Publisher: IEEE Years: 1986 - Present Most Recent Issue

IEEE Transactions on Aerospace and Electronic Systems

Publisher: IEEE Years: 1965 - Present Most Recent Issue

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Eigenfactor

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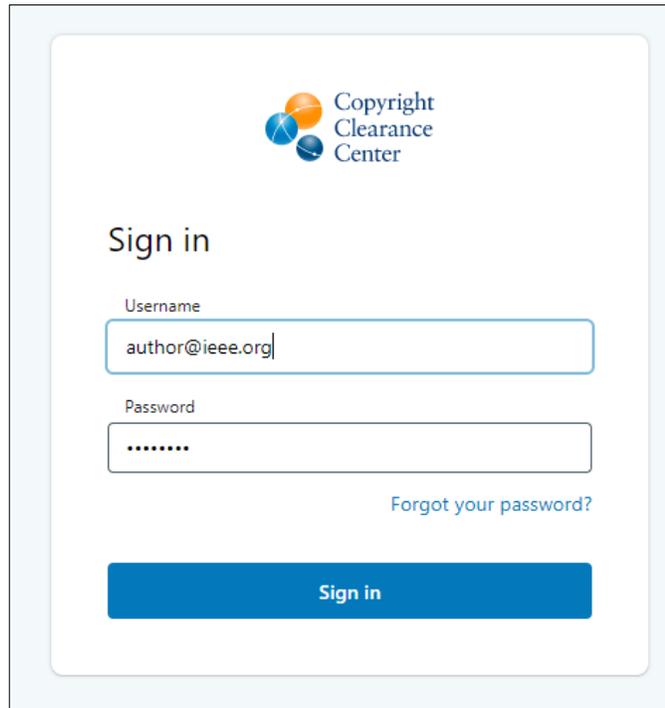


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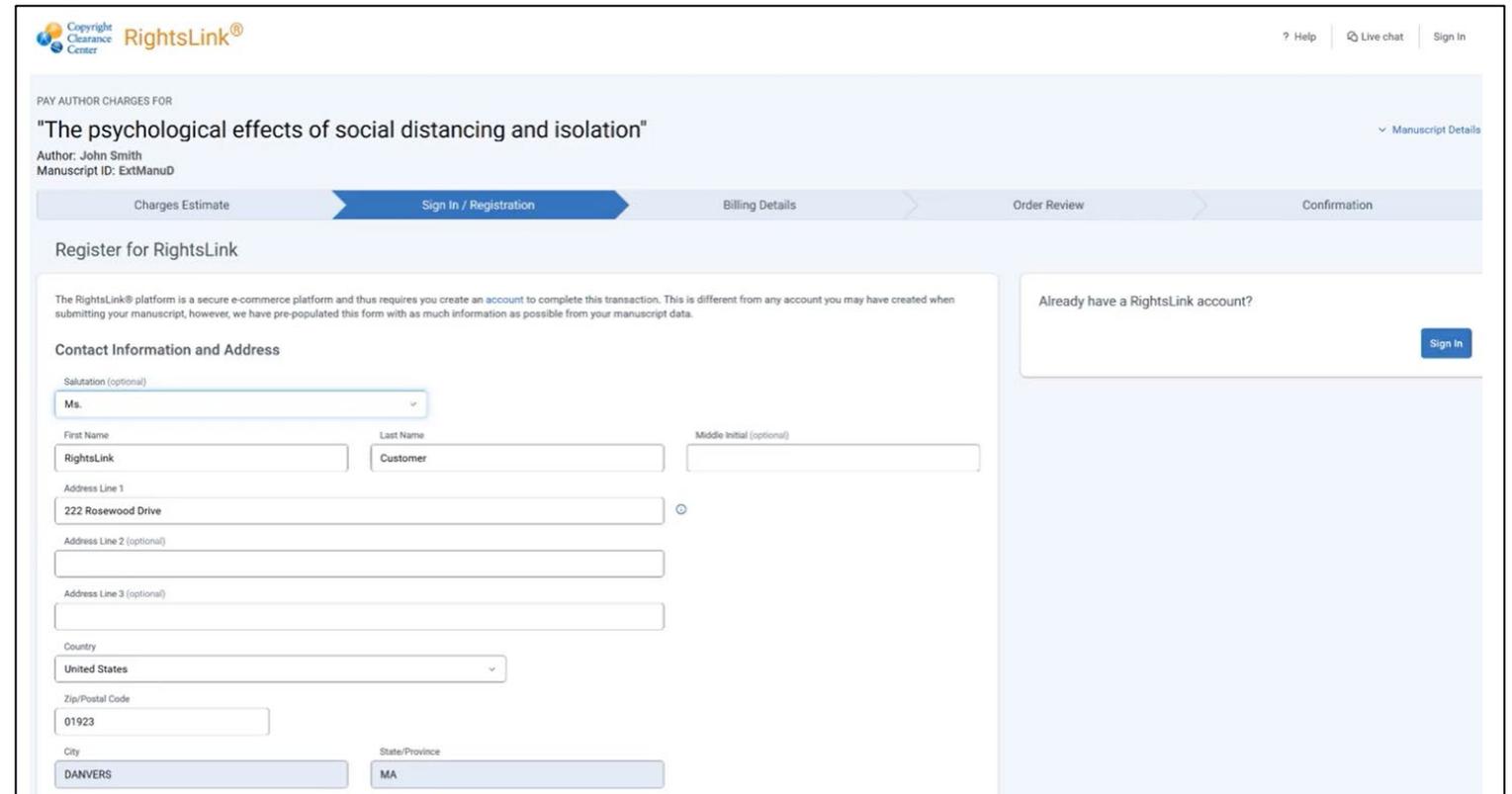
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The image shows a sign-in form for the Copyright Clearance Center RightsLink platform. At the top is the Copyright Clearance Center logo. Below it, the text "Sign in" is displayed. There are two input fields: "Username" with the value "author@ieee.org" and "Password" with a masked input. A link "Forgot your password?" is located below the password field. At the bottom is a blue "Sign in" button.

If funding is NOT available or denied, author is paying the open access charges.



The image shows the RightsLink registration page. At the top, it says "Copyright Clearance Center RightsLink®" and "PAY AUTHOR CHARGES FOR 'The psychological effects of social distancing and isolation'". Below this, it lists the author as "John Smith" and the manuscript ID as "ExtManuD". A progress bar shows the current step is "Sign in / Registration". The main heading is "Register for RightsLink". A note explains that the platform requires account creation. The "Contact Information and Address" section includes a dropdown for "Salutation (optional)" set to "Ms.", and input fields for "First Name" (RightsLink), "Last Name" (Customer), and "Middle Initial (optional)". Address fields include "Address Line 1" (222 Rosewood Drive), "Address Line 2 (optional)", and "Address Line 3 (optional)". The "Country" dropdown is set to "United States", and the "Zip/Postal Code" is "01923". The "City" is "DANVERS" and the "State/Province" is "MA". On the right, there is a "Sign in" button for users who already have an account.

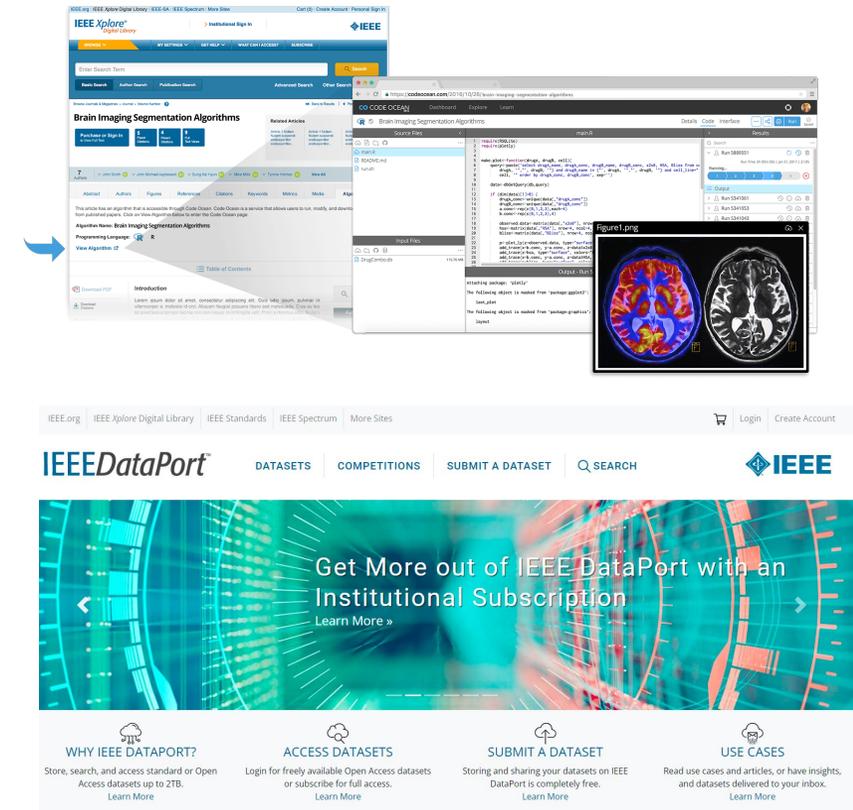
More Open Science Initiatives from IEEE

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In addition to the full-text article, users also want access to data and research artifacts to try to reproduce the results and see if the hypothesis holds. So IEEE introduced:

- **Code Ocean** – Allows authors to publish code or algorithms associated with research articles in a computable environment and linked to IEEE *Xplore*. Authors can upload code free of charge and users can access code without a subscription.
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- **TechRxiv** – IEEE launched a new Preprint Server for Engineering and Technology, a service that lets authors post early and fully open versions of their articles, prior to peer review and prior to being published.

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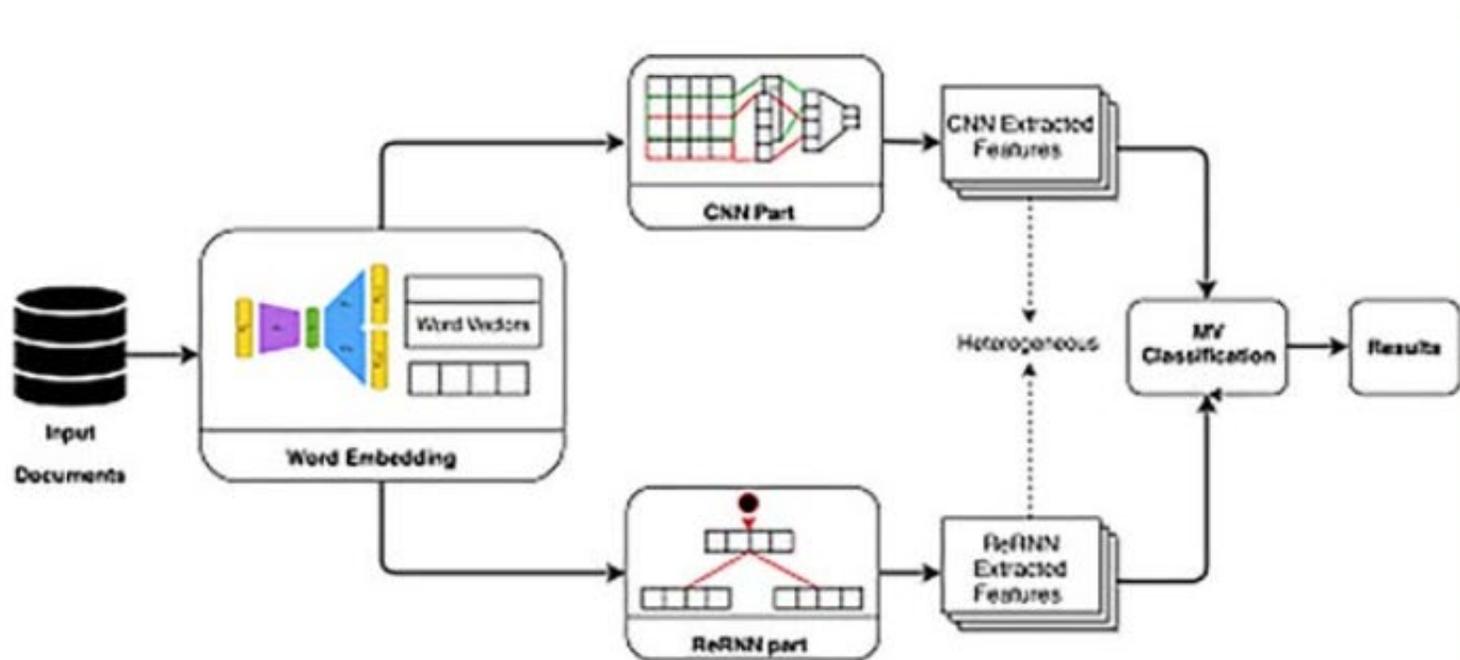
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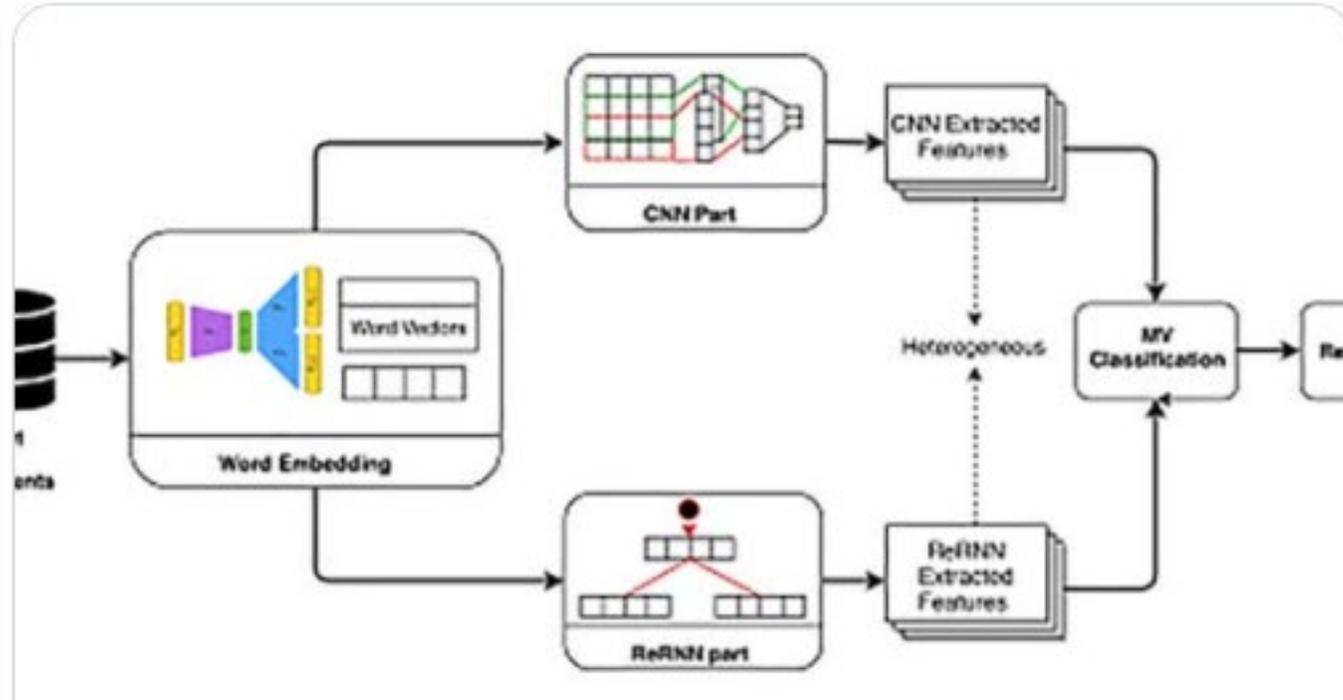
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Abstract

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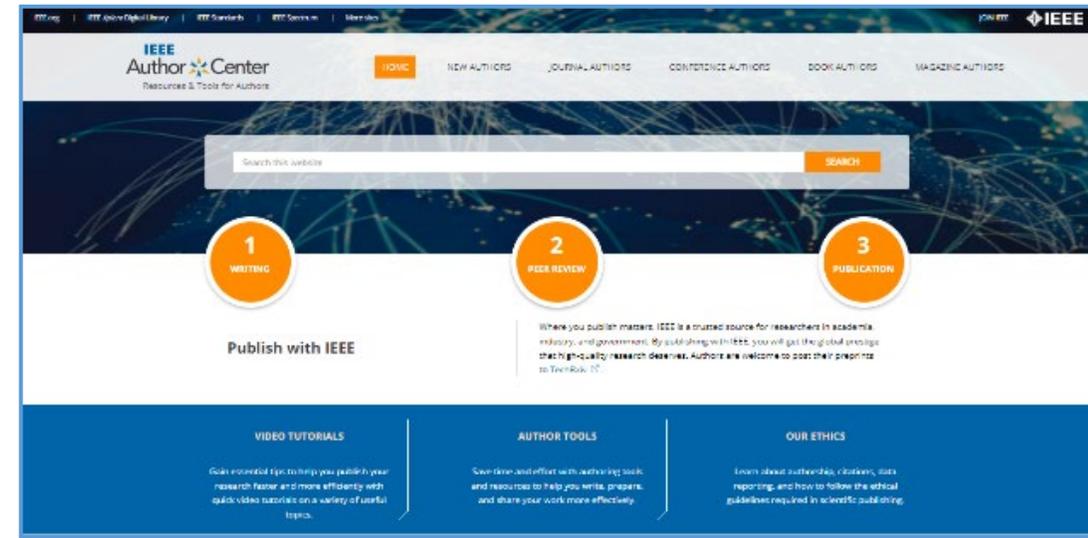
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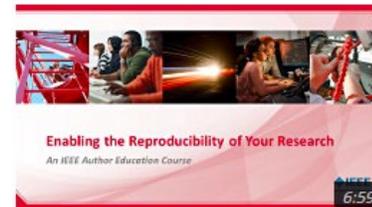
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This issue unveils the IEEE Template Selector, an improved IEEE Author Center, tips on how to craft a strong article title, and an invitation to engage in the IEEE AuthorLab.

The newsletter cover features a dark blue background with a white IEEE logo in the top right. Below the title, it lists the volume and issue information. A yellow banner highlights the 'Inside this Issue' section. The main feature is a white laptop displaying a website interface, with the text 'Download Your Article Template Easily with the IEEE Template Selector' overlaid. A blue wavy graphic is at the bottom.

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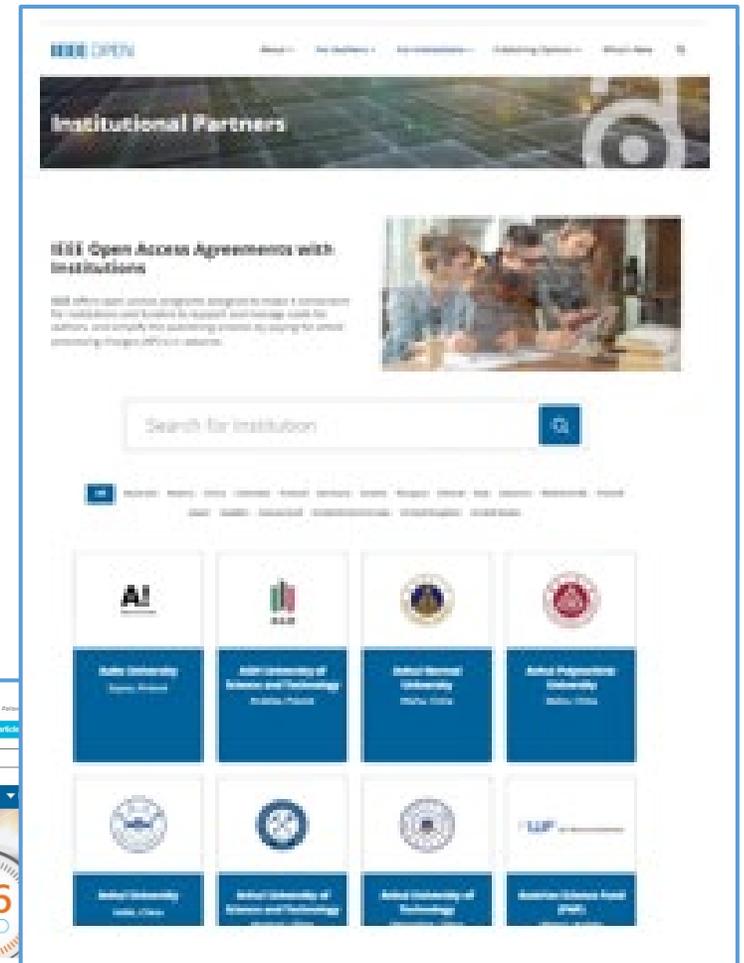
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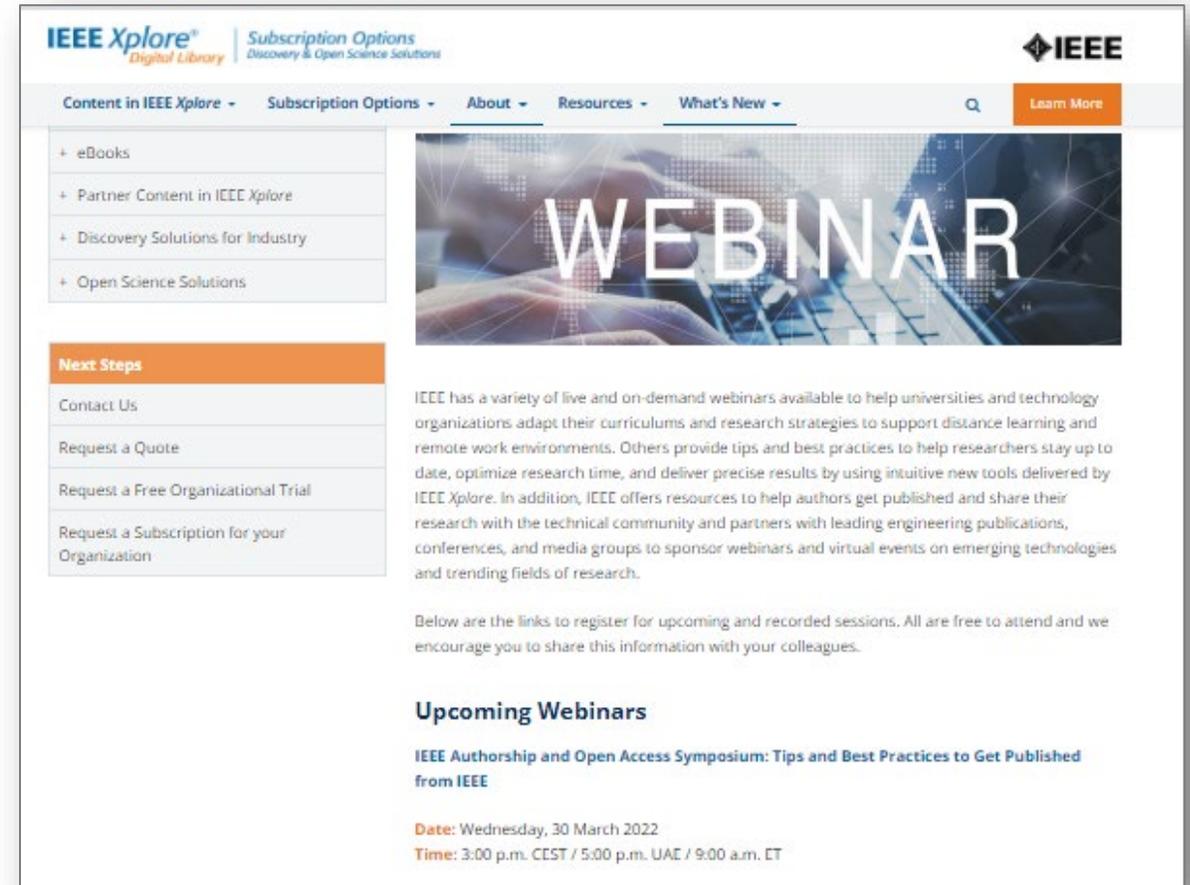
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The screenshot shows the IEEE Xplore website interface. At the top, there is a navigation bar with the IEEE Xplore logo, "Subscription Options", and a search bar. Below the navigation bar, there is a sidebar with a list of content categories: eBooks, Partner Content in IEEE Xplore, Discovery Solutions for Industry, and Open Science Solutions. The main content area features a large banner with the word "WEBINAR" in white text over a background image of hands typing on a keyboard. Below the banner, there is a "Next Steps" section with four links: Contact Us, Request a Quote, Request a Free Organizational Trial, and Request a Subscription for your Organization. The main text describes the variety of live and on-demand webinars available to help universities and technology organizations adapt their curriculums and research strategies. It also mentions that IEEE offers resources to help authors get published and share their research. Below the text, there is a section for "Upcoming Webinars" with a link to "IEEE Authorship and Open Access Symposium: Tips and Best Practices to Get Published from IEEE". The date is listed as Wednesday, 30 March 2022, and the time is 3:00 p.m. CEST / 5:00 p.m. UAE / 9:00 a.m. ET.

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Thank you for your time today!

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Appendix

Additional Slides

Supplemental idem-Video recording of conference presentations – ISCAS 2020

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Virtual, October 10-21, 2020



Design Trade-offs for Neural Stimulators Optimization

Ali H. Hassan¹, Zyad E. Mohamedy¹, Ahmed E. Fahmy¹,
Hassan Mostafa^{1,2}, and Ahmed M. Soliman¹

¹Electronics and Communications Engineering Department, Cairo University

²Nanotechnology and Nanoelectronics Program, Zewail City of Science and Technology

2020 IEEE International Symposium on Circuits and Systems
Virtual, October 10-21, 2020



Supplemental idem – Code and Research data



COSCO: Container Orchestration Using Co-Simulation and Gradient Based Optimization for Fog Computing Environments



Shreshth Tuli; Shivananda R. Poojara; Satish N. Srirama; Giuliano Casale; Nicholas R. Jennings

IEEE Transactions on Parallel and Distributed Systems

Year: 2022 | Volume: 33, Issue: 1 | Journal Article | Publisher: IEEE

▶ Abstract

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A2GAN: A Deep Reinforcement-Based Learning Algorithm for Risk-Aware in Finance



Tuyen Pham Le; Cheolkyun Rho; Yelin Min; Sungreong Lee; Daewoo Choi

IEEE Access

Year: 2021 | Volume: 9 | Journal Article | Publisher: IEEE

▶ Abstract

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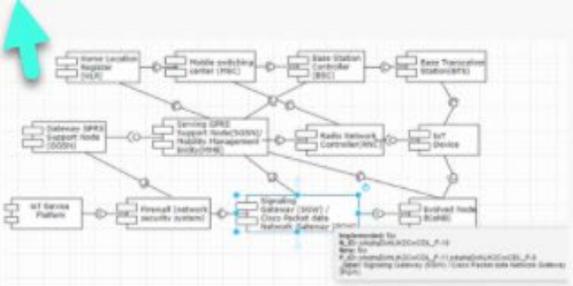
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Supplemental idem – Research data



IoT SPECIFICATIONS, TRACEABILITY MATRIX AND TEST CASES BASED ON GSM



Citation Author(s): Noha Medhat
Sherin Moussa (Associate Professor)

Submitted by: Sherin Moussa

Last updated: Wed, 10/14/2020 - 10:41

DOI: 10.21227/f3j5-nm63

Data Format: *.mp4; *.xlsx

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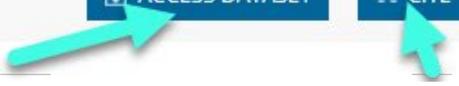
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The screenshot shows the IEEE Xplore article page for the paper "When Slepian Meets Fiedler: Putting a Focus on the Graph Spectrum" by Dimitris V. De Wille, Robin Dammerschke, and Marie Quirin Prell. The article is published in IEEE Signal Processing Letters, Volume 24, Issue 7, July 2017. The page includes an abstract, document sections (Introduction, Defining Slepian Functions on Graphs, Link with Laplacian Embedding and Graph Clustering, Results and Discussion), and a Code Ocean widget. The widget displays a 3D visualization of a tiger with a colorful, striped pattern, representing the graph spectrum. The widget also shows the article title, authors, and a list of files for download, including MATLAB scripts and a Jupyter notebook. The Code Ocean logo is visible at the bottom of the widget.

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 - GSR signal database collected while solving 3D puzzles and relaxation responses...** (Includes a line graph)
 - Mock Dataset:** (Includes a world map)
 - Energy-efficient indoor localization WiFi-fingerprint dataset:** (Includes an image of Earth)
 - Slip suppression of prosthetic hand:** (Includes an image of a person wearing a prosthetic hand)
 - Anomaly Detection with Laser Heat Treatment Thermal Videos:** (Includes a heatmap visualization)
 - Electrophysiologically-identified motor points of forearm muscles:** (Includes a diagram of a hand with electrode locations)
 - Fractional-Slot PMSMs with One Coil Parallel Branches Made Phases: Topological...** (Includes an image of a train tunnel)
 - TestData for the case HE-IES:** (Includes a document snippet with Chinese text)
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